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- Meets or Exceeds the Requirements of TIA/EIA-422-B, TIA/EIA-485-A, and ITU Recommendation V.11
- Bus Voltage Range . . . –7 V to 12 V
- Positive- and Negative-Current Limiting
- Driver Output Capability . . . 60 mA Max
- Driver Thermal-Shutdown Protection
- Receiver Input Impedance . . . 12 kΩ Min
- Receiver Input Sensitivity . . . ±200 mV
- Receiver Input Hysteresis . . . 50 mV Typ
- Operates From Single 5-V Supply
- Low Power Requirements

#### description

The SN75179B is a differential driver and receiver pair designed for balanced transmission-line applications and meets TIA/EIA-422-B, TIA/EIA-485-A, and ITU Recommendation V.11. It is designed to improve the performance of full-duplex data communications over long bus lines.

The SN75179B driver output provides limiting for both positive and negative currents. The receiver features high input impedance, input hysteresis for increased noise immunity, and input sensitivity of  $\pm 200$  mV over a common-mode input voltage range of -7 V to 12 V. The driver provides thermal shutdown for protection from line fault conditions. Thermal shutdown is designed to occur at a junction temperature of approximately 150°C. The SN75179B is designed to drive current loads of up to 60 mA maximum.

The SN75179B is characterized for operation from 0°C to 70°C.

#### **Function Tables**

DRIVER

INPUT	OUT	PUTS
D	Y	Z
Н	Н	L
L	L	н

RECEIVER	
DIFFERENTIAL INPUTS A – B	OUTPUT R
$V_{ID} \ge 0.2 V$	Н
$-0.2 \text{ V} < \text{V}_{\text{ID}} < 0.2 \text{ V}$	?
$V_{ID} \leq -0.2 V$	L
Open	?

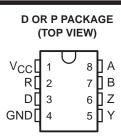
H = high level, L = low level, ? = indeterminate



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

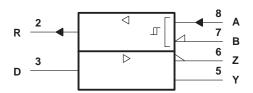




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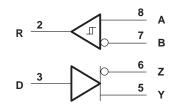
### logic symbol<sup>†</sup>

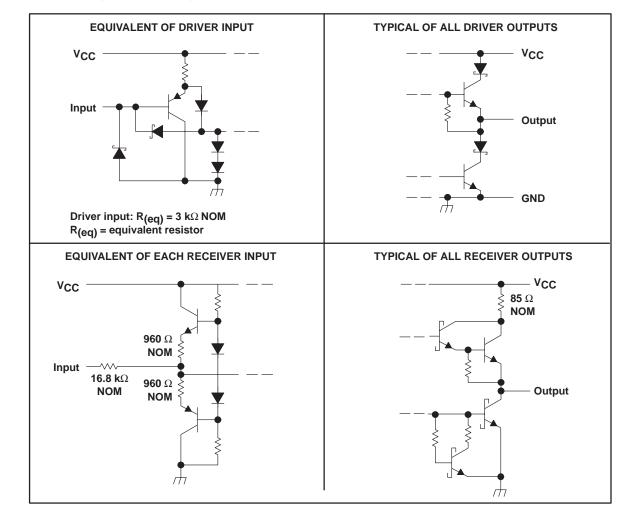


<sup>+</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

### schematics of inputs and outputs

logic diagram (positive logic)







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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage, V <sub>CC</sub> (see Note 1)	
Voltage range at any bus terminal	–10 V to 15 V
Differential input voltage, VID (see Note 2)	±25 V
Package thermal impedance, $\theta_{JA}$ (see Note 3): D package	197°C/W
P package	104°C/W
Storage temperature range, T <sub>sto</sub>	−65°C to 150°C
Storage temperature range, T <sub>stg</sub> Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

<sup>+</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential input voltage, are with respect to network ground terminal.

2. Differential input voltage is measured at the noninverting input with respect to the corresponding inverting input.

3. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

#### recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>		4.75	5	5.25	V
High-level input voltage, VIH	Driver	2			V
Low-level input voltage, VIL	Driver			0.8	V
Common-mode input voltage, VIC		-7‡		12	V
Differential input voltage, VID				±12	V
	Driver			-60	mA
High-level output current, IOH	Receiver			-400	μA
	Driver			60	A
Low-level output current, IOL	Receiver			8	mA
Operating free-air temperature, TA		0		70	°C

<sup>‡</sup> The algebraic convention, where the less positive (more negative) limit is designated minimum, is used in this data sheet for common-mode input voltage and threshold voltage.



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### DRIVER SECTION

# electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

	PARAMETER	TEST CC	NDITIONS	MIN	TYP <sup>†</sup>	MAX	UNIT
VIK	Input clamp voltage	I <sub>I</sub> = -18 mA				-1.5	V
VO	Output voltage	IO = 0		0		6	V
V <sub>OD1</sub>	Differential output voltage	$I_{O} = 0$		1.5		6	V
VOD2	Differential output voltage	R <sub>L</sub> = 100 Ω,	See Figure 1	1/2VOD1 or 2‡			V
		R <sub>L</sub> = 54 Ω,	See Figure 1	1.5	2.5	5	V
VOD3	Differential output voltage	See Note 4		1.5		5	V
∆ V <sub>OD</sub>	Change in magnitude of common-mode output voltage§					±0.2	V
Voc	Common-mode output voltage	$R_L = 54 $ Ω or 100 Ω,	See Figure 1			3 -1	V
∆ V <sub>OC</sub>	Change in magnitude of common-mode output voltage§					±0.2	V
lO	Output current	$V_{CC} = 0,$	$V_{O} = -7 V$ to 12 V			±100	μA
Ιн	High-level input current	V <sub>I</sub> = 2.4 V				20	μA
۱ <sub>IL</sub>	Low-level input current	V <sub>I</sub> = 0.4 V				-200	μA
1	Chart aircuit autout aurrant	$V_0 = -7 V$				-250	A
los	Short-circuit output current	$V_{O} = V_{CC} \text{ or } 12 \text{ V}$				250	mA
ICC	Supply current (total package)	No load			57	70	mA

<sup>†</sup> All typical values are at V<sub>CC</sub> = 5 V and T<sub>A</sub> = 25°C.

 $\ddagger$  The minimum V\_{OD2} with 100- $\Omega$  load is either 1/2 V\_{OD2} or 2 V, whichever is greater.

 $\Delta |V_{OD}|$  and  $\Delta |V_{OC}|$  are the changes in magnitude of  $V_{OD}$  and  $V_{OC}$ , respectively, that occur when the input changes from a high level to a low level.

NOTE 4: See TIA/EIA-485-A, Figure 3.5, Test Termination Measurement 2.

### switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$

	PARAMETER	TEST CO	NDITIONS	MIN	TYP	MAX	UNIT
td(OD)	Differential output delay time	Rι = 54 Ω.	Soo Figuro 2		15	22	ns
tt(OD)	Differential output transition time	R <sub>L</sub> = 54 Ω,	See Figure 3		20	30	ns

#### **Symbol Equivalents**

DATA-SHEET PARAMETER	TIA/EIA-422-B	TIA/EIA-485-A
VO	V <sub>oa</sub> , V <sub>ob</sub>	V <sub>oa</sub> , V <sub>ob</sub>
VOD1	Vo	Vo
IVOD2	V <sub>t</sub> (R <sub>L</sub> = 100 Ω)	$V_t (R_L = 54 \Omega)$
IV <sub>OD3</sub> I		$V_t$ (Test Termination Measurement 2)
$\Delta  V_{OD} $	$  V_t  -  \overline{V}_t  $	$  V_t  -  \overline{V}_t  $
Voc	V <sub>OS</sub>	V <sub>os</sub>
	$ V_{OS} - \overline{V}_{OS} $	$ V_{OS} - \overline{V}_{OS} $
IOS	I <sub>sa</sub>  ,  I <sub>sb</sub>	
IO	I <sub>xa</sub>  ,  I <sub>xb</sub>	lia, lib



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## **RECEIVER SECTION**

# electrical characteristics over recommended ranges of common-mode input voltage, supply voltage, and operating free-air temperature (unless otherwise noted)

	PARAMETER	TE	MIN	TYP†	MAX	UNIT		
VIT+	Positive-going input threshold voltage	V <sub>O</sub> = 2.7 V,	$I_{O} = -0.4 \text{ mA}$				0.2	V
VIT-	Negative-going input threshold voltage	V <sub>O</sub> = 0.5 V,	IO = 8 mA		-0.2‡			V
V <sub>hys</sub>	Hysteresis voltage (V <sub>IT +</sub> - V <sub>IT -</sub> )					50		mV
VOH	High-level output voltage	V <sub>ID</sub> = 200 mV,	$I_{OH} = -400 \ \mu A$ ,	See Figure 2	2.7			V
VOL	Low-level output voltage	$V_{ID} = -200 \text{ mV},$	I <sub>OL</sub> = 8 mA,	See Figure 2			0.45	V
	Line input ourrent	Other input at 0.V	See Note 5	VI = 12 V			1	mA
1	Line input current	Other input at 0 V,	See Note 5	$V_{I} = -7 V$			-0.8	mA
r <sub>i</sub>	Input resistance				12			kΩ
IOS	Short-circuit output current				-15		-85	mA
ICC	Supply current (total package)	No load				57	70	mA

<sup>†</sup> All typical values are at  $V_{CC}$  = 5 V,  $T_A$  = 25°C.

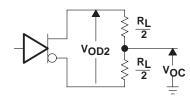
<sup>‡</sup> The algebraic convention, where the less positive (more negative) limit is designated minimum, is used in this data sheet for common-mode input voltage and threshold voltage levels only.

NOTE 5: Refer to TIA/EIA-422-B for exact conditions.

## switching characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<sup>t</sup> PLH	Propagation delay time, low- to high-level output	V <sub>ID</sub> = −1.5 V to 1.5 V,		19	35	ns
<sup>t</sup> PHL	Propagation delay time, high- to low-level output	$C_L = 15 \text{ pF},$ See Figure 4		30	40	ns

#### PARAMETER MEASUREMENT INFORMATION





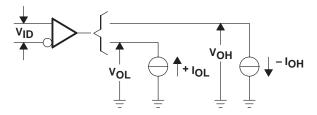
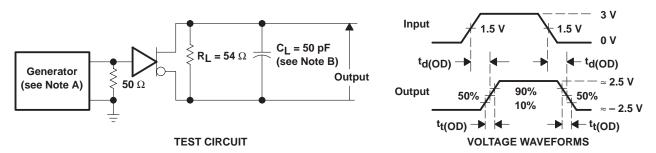


Figure 2. Receiver  $V_{OH}$  and  $V_{OL}$ 



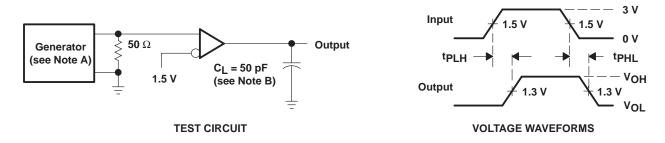
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### PARAMETER MEASUREMENT INFORMATION (CONTINUED)



- NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR  $\leq$  1 MHz, 50% duty cycle, t<sub>f</sub>  $\leq$  6 ns, t<sub>f</sub>  $\leq$  6 ns, Z<sub>O</sub> = 50  $\Omega$ .
  - B. CL includes probe and jig capacitance.

#### Figure 3. Driver Test Circuit and Voltage Waveforms

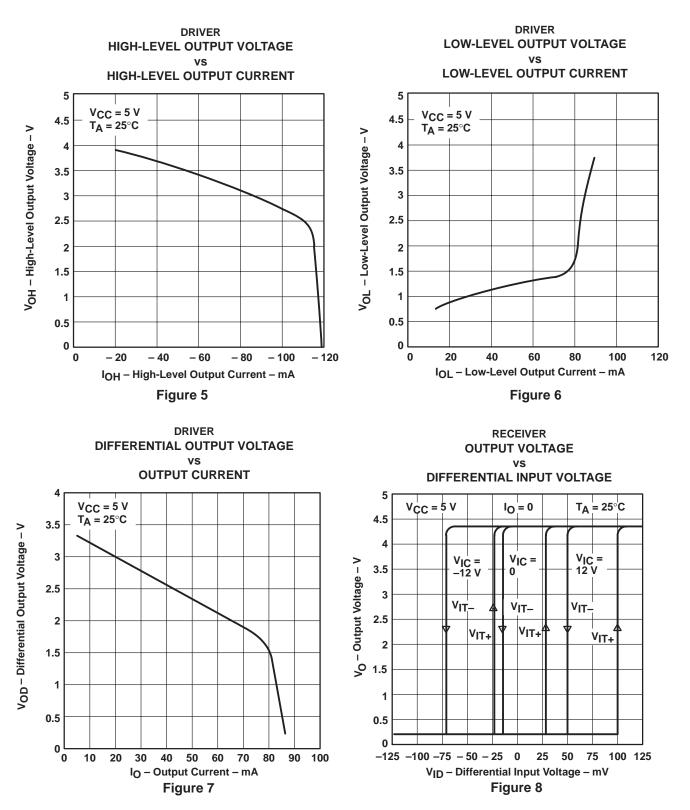


- NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR  $\leq$  1 MHz, 50% duty cycle, t<sub>r</sub>  $\leq$  6 ns, t<sub>f</sub>  $\leq$  6 ns, Z<sub>O</sub> = 50  $\Omega$ .
  - B.  $C_L$  includes probe and jig capacitance.

#### Figure 4. Receiver Test Circuit and Voltage Waveforms



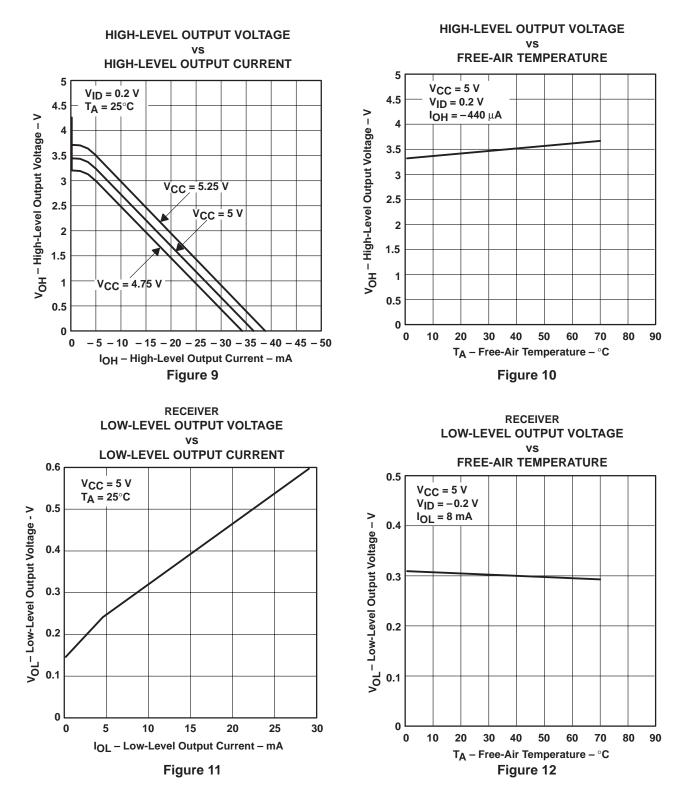
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### **TYPICAL CHARACTERISTICS**



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24-Aug-2018

## PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
SN75179BD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	75179B	Samples
SN75179BDE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	75179B	Samples
SN75179BDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	75179B	Samples
SN75179BDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	75179B	Samples
SN75179BP	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN75179BP	Samples
SN75179BPE4	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN75179BP	Samples
SN75179BPSR	ACTIVE	SO	PS	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	A179B	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <= 1000ppm threshold. Antimony trioxide based flame retardants must also meet the <= 1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.



# PACKAGE OPTION ADDENDUM

24-Aug-2018

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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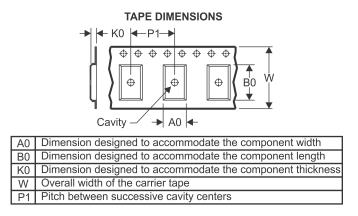
# PACKAGE MATERIALS INFORMATION

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### TAPE AND REEL INFORMATION





# QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal	
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Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN75179BDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

TEXAS INSTRUMENTS

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# PACKAGE MATERIALS INFORMATION

20-Dec-2018



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN75179BDR	SOIC	D	8	2500	340.5	338.1	20.6

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AA.





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



### **MECHANICAL DATA**

## PS (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



P(R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001 variation BA.



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